



## 13MHz, Rail-to-Rail I/O CMOS Operational Amplifier

### 1 FEATURES

- Qualified for Automotive Applications
- AEC-Q100 Qualified with the Grade 1
- HIGH GAIN BANDWIDTH: 13MHz
- RAIL-TO-RAIL INPUT AND OUTPUT ±0.5mV Typical Vos
- INPUT VOLTAGE RANGE: -0.1V to +5.6V with  $V_s = 5.5V$
- SUPPLY RANGE: +2.7V to +5.5V
- SPECIFIED UP TO +125°C
- Micro SIZE PACKAGES: SOT23-5, SOP8

### **2 APPLICATIONS**

- SENSORS
- PHOTODIODE AMPLIFICATION
- ACTIVE FILTERS
- TEST EQUIPMENT
- DRIVING A/D CONVERTERS

### **3 DESCRIPTIONS**

The RS72XP-Q1 families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (13MHz) and slew rate of 8V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS72XP-Q1 families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.7V to 5.5V.

#### **Device Information**<sup>(1)</sup>

| PART<br>NUMBER | PACKAGE | BODY SIZE (NOM) |
|----------------|---------|-----------------|
| RS721P-Q1      | SOT23-5 | 2.92mm×1.62mm   |
| RS722P-Q1      | SOP8    | 4.90mm×3.90mm   |
| K3722P-Q1      | MSOP8   | 3.00mm×3.00mm   |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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**4 Revision History** Note: Page numbers for previous revisions may different from page numbers in the current version.

| VERSION | Change Date | Change Item   |  |
|---------|-------------|---|--|
| A.1     | 2022/10/18  | Official version completed                                |  |
|         |             | 1. Update IB/Ios in 7.4 ELECTRICAL CHARACTERISTICS        |  |
| A.2     | 2023/02/16  | 2. Add Ios、PSRR、CMRR curve in 7.5 TYPICAL CHARACTERISTICS |  |
|         |             | 3. Update PACKAGE OUTLINE DIMENSIONS                      |  |
| A.3     | 2023/07/03  | Delete RS724P-Q1related content                           |  |
| A.3.1   | 2024/03/07  | Modify packaging naming                                   |  |



### **5 PACKAGE/ORDERING INFORMATION** <sup>(1)</sup>

| Orderable<br>Device | Package<br>Type | Pin | Channel | Lead<br>finish/Ball<br>material <sup>(2)</sup> | MSL Peak<br>Temp <sup>(3)</sup> | Op Temp(°C)  | Device<br>Marking<br>(4) | Package<br>Qty     |
|---------------------|-----------------|-----|---------|--|---------------------------------|--------------|--------------------------|--------------------|
| RS721PXF<br>-Q1     | SOT23-5         | 5   | 1       | NIPDAUAG                                       | MSL1-260°<br>-Unlimited         | -40°C ~125°C | 721P                     | Tape and Reel,3000 |
| RS722PXK<br>-Q1     | SOP8            | 8   | 2       | NIPDAUAG                                       | MSL1-260°<br>-Unlimited         | -40°C ~125°C | RS722P                   | Tape and Reel,4000 |
| RS722PXM<br>-Q1     | MSOP8           | 8   | 2       | NIPDAUAG                                       | MSL1-260°<br>-Unlimited         | -40°C ~125°C | RS722P                   | Tape and Reel,4000 |

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

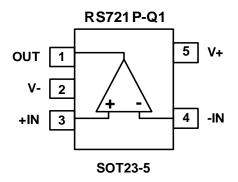
(2) Lead finish/Ball material. Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(3) MSL Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.



### 6 Pin Configuration and Functions (Top View)



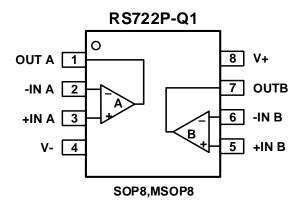
### **Pin Description**

| PIN       |   |   |
|-----------|---|---|
| RS721P-Q1 | I/O <sup>(1)</sup>  | DESCRIPTION   |
| SOT23-5   |   |   |
| 4         | I   | Negative (inverting) input  |
| 3         | I   | Positive (noninverting) input   |
| 1         | 0   | Output  |
| 2         | -   | Negative (lowest) power supply  |
| 5         | -   | Positive (highest) power supply   |
|           | RS721P-Q1           SOT23-5           4           3           1           2 | RS721P-Q1         I/O (1)           SOT23-5         I           4         I           3         I           1         O           2         -           5         - |

(1) I = Input, O = Output.



### Pin Configuration and Functions (Top View)



### **Pin Description**

|      | PIN        |                    |                                 |
|------|------------|--------------------|---------------------------------|
| NAME | RS722P-Q1  | I/O <sup>(1)</sup> | DESCRIPTION                     |
|      | SOP8/MSOP8 |                    |                                 |
| -INA | 2          | I                  | Inverting input, channel A      |
| +INA | 3          | I                  | Noninverting input, channel A   |
| -INB | 6          | I                  | Inverting input, channel B      |
| +INB | 5          | I                  | Noninverting input, channel B   |
| OUTA | 1          | 0                  | Output, channel A               |
| OUTB | 7          | 0                  | Output, channel B               |
| V-   | 4          | -                  | Negative (lowest) power supply  |
| V+   | 8          | -                  | Positive (highest) power supply |

(1) I = Input, O = Output.



### **7 SPECIFICATIONS**

#### 7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

|                 |   |         | MIN      | MAX        | UNIT |
|-----------------|---|---------|----------|------------|------|
|                 | Supply, V <sub>S</sub> =(V+) - (V-)     |         |          | 7          |      |
| Voltage         | Signal input pin <sup>(2)</sup>         |         | (V-)-0.5 | (V+) +0.5  | V    |
|                 | Signal output pin <sup>(3)</sup>        |         | (V-)-0.5 | (V+) +0.5  |      |
|                 | Signal input pin <sup>(2)</sup>         |         | -10      | 10         | mA   |
| Current         | Signal output pin <sup>(3)</sup>        |         | -200     | 200        | mA   |
|                 | Output short-circuits <sup>(4)</sup>    |         | Cont     | Continuous |      |
|                 |   | SOT23-5 |          | 230        |      |
| θ <sub>JA</sub> | Package thermal impedance (5)           | SOP8    |          | 110        | °C/W |
|                 |   | MSOP8   |          | 170        |      |
|                 | Operating range, T <sub>A</sub>         |         | -40      | 125        |      |
| Temperature     | Junction, T <sub>J</sub> <sup>(6)</sup> |         | -40      | 150        | °C   |
|                 | Storage, T <sub>stg</sub>               |         | -65      | 150        |      |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

(3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ±200mA or less.

(4) Short-circuit to ground, one amplifier per package.

(5) The package thermal impedance is calculated in accordance with JESD-51.

(6) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $R_{\theta JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$ . All numbers apply for packages soldered directly onto a PCB.

#### 7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

|        |                         |   | VALUE | UNIT |
|--------|-------------------------|---|-------|------|
|        |                         | Human-Body Model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 | V    |
| V(ESD) | Electrostatic discharge | Charged-Device Model (CDM), per AEC Q100-011            | ±500  | v    |
|        |                         | Latch-Up (LU), per AEC Q100-004                         | ±100  | mA   |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



#### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted).

|  |               | MIN   | NOM | MAX   | UNIT |
|--|---------------|-------|-----|-------|------|
| Supply voltage, V <sub>S</sub> = (V+) - (V-) | Single-supply | 2.7   |     | 5.5   | V    |
|  | Dual-supply   | ±1.35 |     | ±2.75 | v    |



### 7.4 ELECTRICAL CHARACTERISTICS

(At  $T_A = +25^{\circ}C$ ,  $V_S=2.7V$  to 5.5V,  $R_L = 10k\Omega$  connected to  $V_S/2$ , and  $V_{OUT} = V_S/2$ , Full <sup>(9)</sup> = -40°C to +125°C, unless otherwise noted.) <sup>(1)</sup>

|                                   | PARAMETER                                       | CONDITIONS   | Тı   | RS72XP-Q1          |                    |                    |       |
|-----------------------------------|---|--|------|--------------------|--------------------|--------------------|-------|
|                                   | PARAMETER                                       | CONDITIONS   | IJ   | MIN <sup>(2)</sup> | TYP <sup>(3)</sup> | MAX <sup>(2)</sup> | UNIT  |
| POWER                             | R SUPPLY  |  |      |                    |                    |                    |       |
| Vs                                | Operating Voltage Range                         |  | 25°C | 2.7                |                    | 5.5                | V     |
| IQ                                | Quiescent Current/Amplifier                     | Vs=±2.5V, Io=0mA   | 25°C |                    | 1.15               | 1.35               |       |
|                                   | Quescent Current/Ampliner                       | $VS=\pm 2.5V, 10=011A$   | Full |                    |                    | 1.85               | mA    |
| DODD                              | Power-Supply Rejection Ratio                    | Vs=2.7V to 5.5V  | 25°C | 75                 | 93                 |                    | dB    |
| PSRR Power-Supply Rejection Ratio |   | VS=2.7 V 10 5.5 V  | Full | 70                 |                    |                    | uD    |
| INPUT                             |   |  |      | -                  |                    |                    |       |
| Vos                               | Input Offset Voltage                            | V <sub>CM</sub> =Vs/2  | 25°C | -1.5               | ±0.5               | 1.5                | mV    |
| V03                               |   | V CM - V 3/2   | Full | -3                 |                    | 3                  | IIIV  |
| Vos Tc                            | Input Offset Voltage Average<br>Drift           |  | Full |                    | ±2.6               |                    | uV/°C |
| ю                                 | Input Pige Current (4) (5)                      | Maria Ma/2   | 25°C |                    | ±1                 | ±10                | pА    |
| IB                                | Input Bias Current <sup>(4) (5)</sup>           | V <sub>CM</sub> =Vs/2  | Full |                    | 0.5                | ±10                | nA    |
| laa                               | Input Offset Current <sup>(5)</sup>             | V <sub>CM</sub> =V <sub>S</sub> /2                             | 25°C |                    | ±1                 | ±10                | pА    |
| los                               | input Onset Current (*)                         |  | Full |                    |                    | ±10                | nA    |
| Vсм                               | Common-Mode Voltage Range                       | Vs= 5.5V   | 25°C | -0.1               |                    | 5.6                | V     |
|                                   | Common-Mode Rejection Ratio                     | Vs= 5.5V, Vcm=-0.1V<br>to 3.5V<br>Vs= 5.5V, Vcm=-0.1V          | 25°C | 73                 | 90                 |                    | dB    |
| CMRR                              |   |  | Full | 70                 |                    |                    |       |
| CIVILAT                           |   |  | 25°C | 60                 | 77                 |                    |       |
|                                   |   | to 5.6V  | Full | 59                 |                    |                    |       |
| OUTPU                             | T   |  |      | -                  |                    |                    |       |
| Aol                               | Open-Loop Voltage Gain                          | R∟=10KΩ, Vo=(V-)   | 25°C | 110                | 127                |                    | dB    |
| NOL                               |   | +0.1V to (V+)-0.1V   | Full | 94                 |                    |                    |       |
|                                   | Output Swing from Rail                          | Vs=±2.5V, R∟=10KΩ  | 25°C |                    | 10                 | 20                 | mV    |
|                                   |   | V3-12.0V, TL-TOT32   | Full |                    |                    | 25                 | IIIV  |
| Іоит                              | Output Short-Circuit Current <sup>(6) (7)</sup> | V <sub>S</sub> =±2.5V, Vo=0V                                   | 25°C | ±80                | ±150               |                    | mA    |
| 1001                              |   | V3=±2.5V, V0=0V  | Full | ±60                |                    |                    | 110/  |
| $C_{LOAD}$                        | Capacitive Load Drive                           |  | 25°C |                    | 100                |                    | pF    |
| FREQU                             | ENCY RESPONSE                                   | 1  |      |                    |                    |                    |       |
| SR                                | Slew Rate <sup>(8)</sup>                        | G=+1, C∟=100pF   | 25°C |                    | 8                  |                    | V/us  |
| GBP                               | Gain-Bandwidth Product                          |  | 25°C |                    | 13                 |                    | MHz   |
| ts                                | Settling Time,0.1%                              | V <sub>S</sub> =±2.5V, G=+1,<br>C <sub>L</sub> =100pF, Step=2V | 25°C |                    | 0.8                |                    | us    |
| tor                               | Overload Recovery Time                          | V <sub>IN</sub> .Gain≥V <sub>S</sub> , G=-10                   | 25°C |                    | 0.4                |                    | us    |
| NOISE                             |   |  |      |                    |                    |                    |       |
| En                                | Input Voltage Noise                             | f = 0.1Hz to 10Hz,<br>V <sub>S</sub> =±2.5V                    | 25°C |                    | 5                  |                    | uVpp  |
| En                                | Input Voltage Noise                             | $V_{S}=\pm 2.5V$   | 25°C |                    | 5                  |                    | uVP   |



NOTE:

- (1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
- (4) Positive current corresponds to current flowing into the device.
- (5) This parameter is ensured by design and/or characterization and is not tested in production.
- (6) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $R_{0JA}$ , and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is PD = ( $T_{J(MAX)}$   $T_A$ ) /  $R_{0JA}$ . All numbers apply for packages soldered directly onto a PCB.
- (7) Short circuit test is a momentary test.
- (8) Number specified is the slower of positive and negative slew rates.
- (9) Specified by characterization only.



### 7.5 TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At  $T_A = +25^{\circ}C$ ,  $V_S=5V$ ,  $R_L = 10k\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.

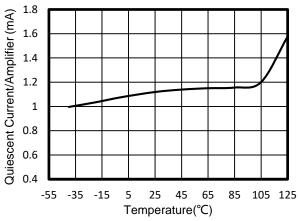


Figure 1. Quiescent Current vs Temperature

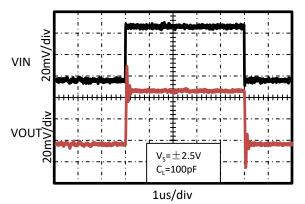
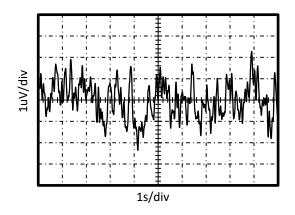


Figure 3. Small-Signal Step Response





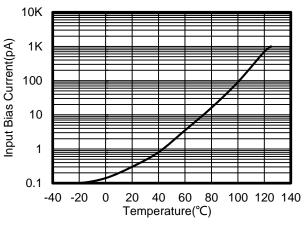
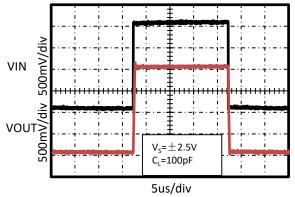


Figure 2. Input Bias Current vs Temperature





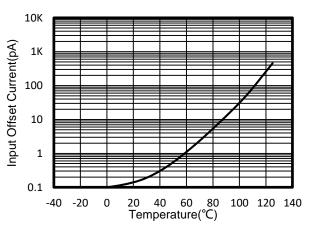


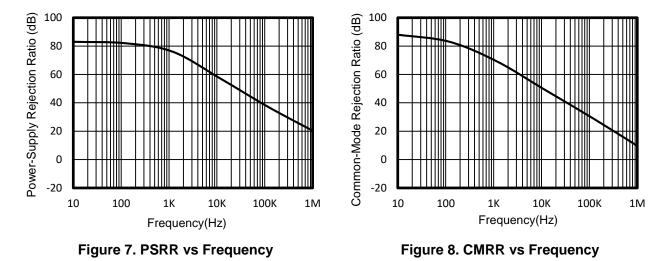
Figure 6. Input Offset Current vs Temperature



### **TYPICAL CHARACTERISTICS**

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At  $T_A = +25^{\circ}C$ ,  $V_S=5V$ ,  $R_L = 10k\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.





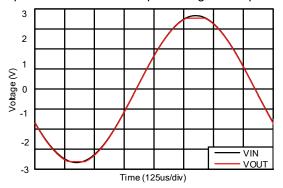
### **8 Detailed Description**

#### 8.1 Overview

The RS721P-Q1, RS722P-Q1 are high precision, rail-to-rail operational amplifiers that can be run from a singlesupply voltage 2.7V to 5.5V ( $\pm$ 1.35V to  $\pm$ 2.75V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

#### 8.2 Phase Reversal Protection

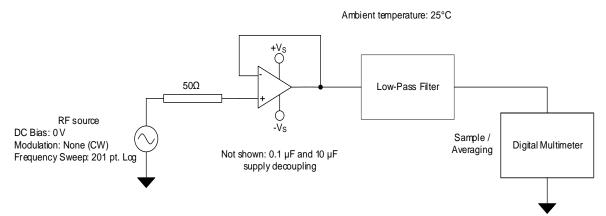
The RS72XP-Q1 family has internal phase-reversal protection. Many op amps exhibit phase reversal when the input is driven beyond the linear common-mode range. This condition is most often encountered in noninverting circuits when the input is driven beyond the specified common-mode voltage range, causing the output to reverse into the opposite rail. The input of the RS72XP-Q1 prevents phase reversal with excessive common-mode voltage. Instead, the appropriate rail limits the output voltage. This performance is shown in figure 9.



#### Figure 9. Output Waveform Devoid of Phase Reversal During an Input Overdrive Condition

#### 8.3 EMIRR IN+ Test Configuration

Figure 10 shows the circuit configuration for testing the EMIRR IN+. An RF source is connected to the operational amplifier noninverting input pin using a transmission line. The operational amplifier is configured in a unity-gain buffer topology with the output connected to a low-pass filter (LPF) and a digital multimeter (DMM). A large impedance mismatch at the operational amplifier input causes a voltage reflection; however, this effect is characterized and accounted for when determining the EMIRR IN+. The resulting dc offset voltage is sampled and measured by the multimeter. The LPF isolates the multimeter from residual RF signals that can interfere with multimeter accuracy.







### 9 Application and Implementation

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 APPLICATION NOTE

The RS72XP-Q1 are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.7V to 5.5V ( $\pm$ 1.35V to  $\pm$ 2.75V). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier. Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

#### Typical Applications 9.2 25-kHz Low-pass Filter

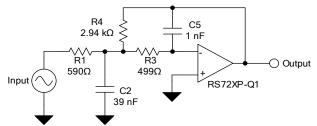


Figure 11. 25-kHz Low-Pass Filter

#### 9.3 Design Requirements

Low-pass filters are commonly employed in signal processing applications to reduce noise and prevent aliasing. The RS72XP-Q1 devices are ideally suited to construct high-speed, high-precision active filters. Figure 11 shows a second-order, low-pass filter commonly encountered in signal processing applications. Use the following parameters for this design example:

- Gain = 5 V/V (inverting gain)
- Low-pass cutoff frequency = 25 kHz
- Second-order Chebyshev filter response with 3-dB gain peaking in the passband.

#### 9.4 Detailed Design Procedure

The infinite-gain multiple-feedback circuit for a low-pass network function is shown in Figure 11. Use Equation 1 to calculate the voltage transfer function.

$$\frac{\text{Output}}{\text{Input}}(s) = \frac{-1/R_1 R_3 C_2 C_5}{S^2 + (S/C_2)(1/R_1 + 1/R_3 + 1/R_4) + 1/R_3 R_4 C_2 C_5}$$
(1)

This circuit produces a signal inversion. For this circuit, the gain at dc and the low-pass cutoff frequency are calculated by Equation 2:

$$Gain = \frac{R_4}{R_1}$$
  
f<sub>c</sub> =  $\frac{1}{2\pi} \sqrt{(1/R_3 R_4 C_2 C_5)}$  (2)





### 9.5 Application Curve

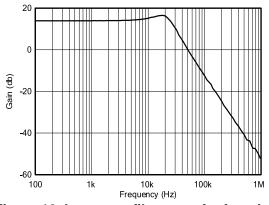


Figure 12. Low-pass filter transfer function



### **10 LAYOUTS**

#### **10.1 Layout Guidelines**

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

### 10.2 Layout Example

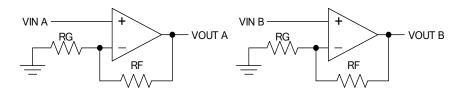
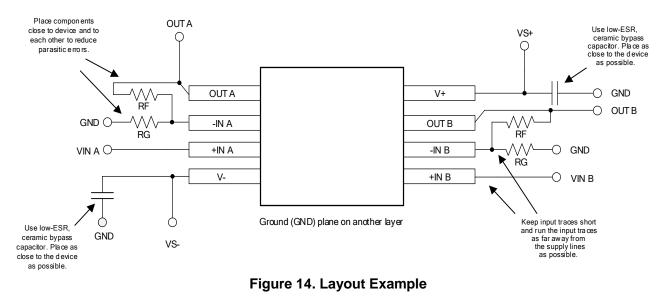


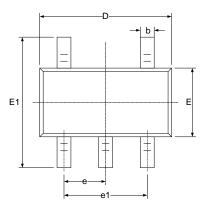
Figure 13. Schematic Representation

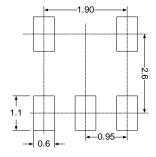


NOTE: Layout Recommendations have been shown for dual op-amp only, follow similar precautions for Single and four.

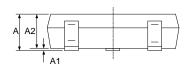


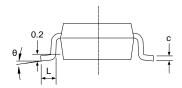
# 11 PACKAGE OUTLINE DIMENSIONS SOT23-5





**RECOMMENDED LAND PATTERN (Unit: mm)** 

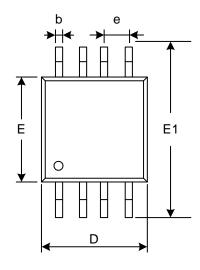


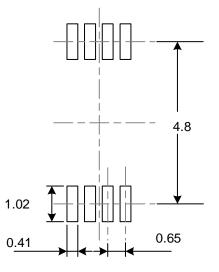


| Symbol | Dimensions | In Millimeters | Dimensions In Inches |       |  |
|--------|------------|----------------|----------------------|-------|--|
| Symbol | Min        | Max            | Min                  | Max   |  |
| A      |            | 1.250          |                      | 0.049 |  |
| A1     | 0.000      | 0.150          | 0.000                | 0.006 |  |
| A2     | 1.000      | 1.200          | 0.039                | 0.047 |  |
| b      | 0.360      | 0.500          | 0.014                | 0.020 |  |
| С      | 0.100      | 0.200          | 0.004                | 0.008 |  |
| D      | 2.826      | 3.026          | 0.111                | 0.119 |  |
| E      | 1.526      | 1.726          | 0.060                | 0.068 |  |
| E1     | 2.600      | 3.000          | 0.102                | 0.118 |  |
| e      | 0.950      | (BSC)          | 0.037                | (BSC) |  |
| e1     | 1.800      | 2.000          | 0.071                | 0.079 |  |
| L      | 0.350      | 0.600          | 0.014                | 0.024 |  |
| θ      | 0°         | 8°             | 0°                   | 8°    |  |

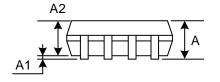


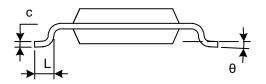
### MSOP8





RECOMMENDED LAND PATTERN (Unit: mm)

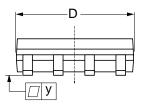


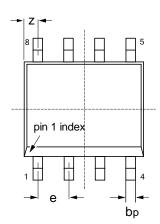


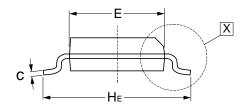
| Symbol | Dimensions | In Millimeters | Dimension | s In Inches |  |
|--------|------------|----------------|-----------|-------------|--|
| Symbol | Min        | Мах            | Min       | Max         |  |
| A      | 0.820      | 1.100          | 0.032     | 0.043       |  |
| A1     | 0.020      | 0.150          | 0.001     | 0.006       |  |
| A2     | 0.750      | 0.950          | 0.030     | 0.037       |  |
| b      | 0.250      | 0.380          | 0.010     | 0.015       |  |
| с      | 0.090      | 0.230          | 0.004     | 0.009       |  |
| D      | 2.900      | 3.100          | 0.114     | 0.122       |  |
| е      | 0.650      | (BSC)          | 0.026     | (BSC)       |  |
| E      | 2.900      | 3.100          | 0.114     | 0.122       |  |
| E1     | 4.750      | 5.050          | 0.187     | 0.199       |  |
| L      | 0.400      | 0.800          | 0.016     | 0.031       |  |
| θ      | 0 °        | 6 °            | 0 °       | <b>6</b> °  |  |

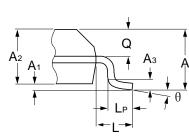


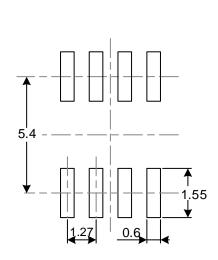
SOP8











RECOMMENDED LAND PATTERN (Unit: mm)

Detail X

| Ormula a L       | Dimensions | In Millimeters | Dimensions In Inches |       |  |  |
|------------------|------------|----------------|----------------------|-------|--|--|
| Symbol           | Min        | Max            | Min                  | Max   |  |  |
| A                |            | 1.750          |                      | 0.069 |  |  |
| A <sub>1</sub>   | 0.100      | 0.250          | 0.004                | 0.010 |  |  |
| A <sub>2</sub>   | 1.250      | 1.450          | 0.049                | 0.057 |  |  |
| A <sub>3</sub>   | 0.         | 25             | 0.010                |       |  |  |
| bp               | 0.360      | 0.490          | 0.014                | 0.019 |  |  |
| С                | 0.190      | 0.250          | 0.007                | 0.010 |  |  |
| D <sup>(A)</sup> | 4.800      | 5.000          | 0.190                | 0.200 |  |  |
| E <sup>(B)</sup> | 3.800      | 4.000          | 0.150                | 0.160 |  |  |
| HE               | 5.800      | 6.200          | 0.228                | 0.244 |  |  |
| е                | 1.:        | 270            | 0.050                |       |  |  |
| L                | 1.         | .05            | 0.041                |       |  |  |
| LP               | 0.400      | 1.000          | 0.016                | 0.039 |  |  |
| Q                | 0.600      | 0.700          | 0.024                | 0.028 |  |  |
| Z <sup>(A)</sup> | 0.300      | 0.700          | 0.012                | 0.028 |  |  |
| У                | 0          | 0.1            | 0.004                |       |  |  |
| θ                | 0°         | 8°             | 0°                   | 8°    |  |  |



NOTE:

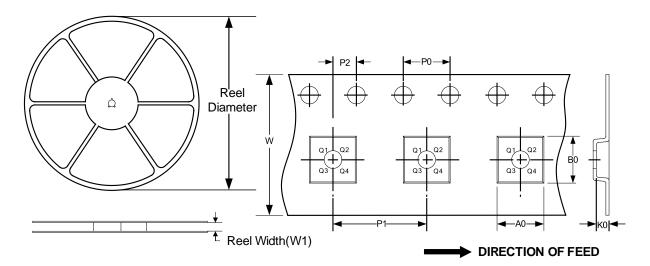
- A. Plastic or metal protrusions of 0.15mm maximum per side are not included.
- B. Plastic interlead protrusions of 0.25mm maximum per side are not included.C. All linear dimension is in millimeters.

- D. This drawing is subject to change without notice.
  E. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  F. BSC: Basic Dimension. Theoretically exact value shown without tolerances.



#### 12 TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

| Package Type | Reel<br>Diameter | Reel<br>Width(mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P0<br>(mm) | P1<br>(mm) | P2<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |  |
|--------------|------------------|-------------------|------------|------------|------------|------------|------------|------------|-----------|------------------|--|
| SOT23-5      | 7"               | 9.5               | 3.20       | 3.20       | 1.40       | 4.0        | 4.0        | 2.0        | 8.0       | Q3               |  |
| SOP8         | 13"              | 12.4              | 6.40       | 5.40       | 2.10       | 4.0        | 8.0        | 2.0        | 12.0      | Q1               |  |
| MSOP8        | 13"              | 12.4              | 5.20       | 3.30       | 1.50       | 4.0        | 8.0        | 2.0        | 12.0      | Q1               |  |

#### **KEY PARAMETER LIST OF TAPE AND REEL**

NOTE:

1. All dimensions are nominal.

2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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